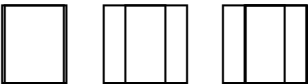


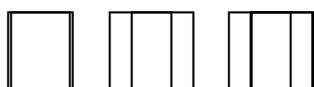
/ Revised record

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F	2017-4				
G	2020-5-15	1	0 1 2 3 4 5 6 7 8 9 : 5 6 ; <	= >	? @ A
A	2022-4-23	all	BC 4 BR/Q 9 0 1) DE 3 4 FG ; < H I J K L AEC-Q101 7 MNOPQRSTUVWXYZ [H \] Q9 ^ _ ` a 245±5°C 9 b c d e ] 5±0.5sec f g ] h ^ _ ` a 255±5°C 9 b c d e] 5± 0.5sec i	= >	j k l
B	2022-7-11	3	3 4 VBE(SAT)-IC/VBE(ON)-IC/CAP ACITANCE-VR/VCE-IB m n o	= >	? @ A

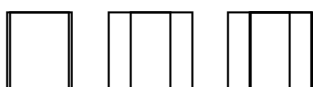
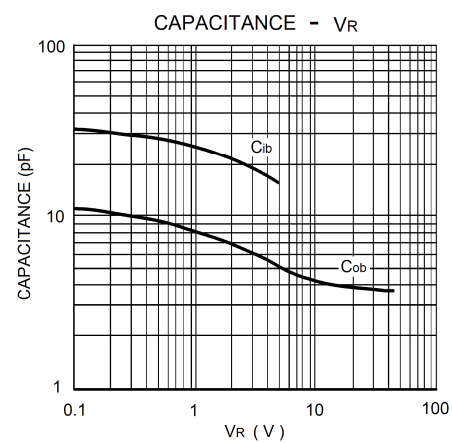
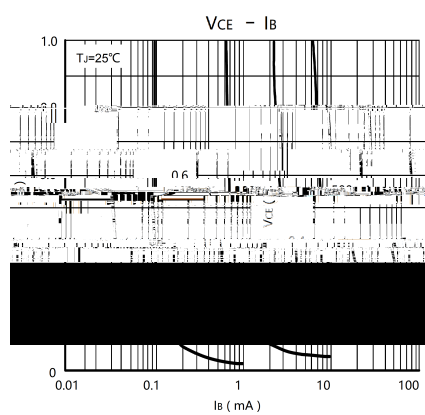
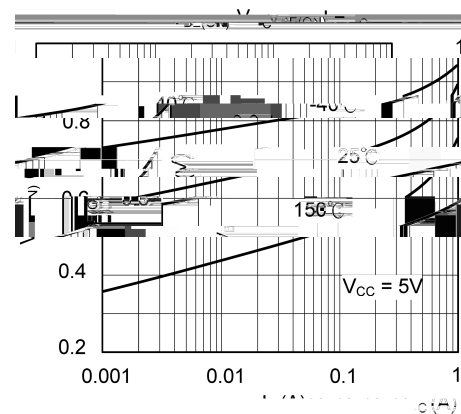
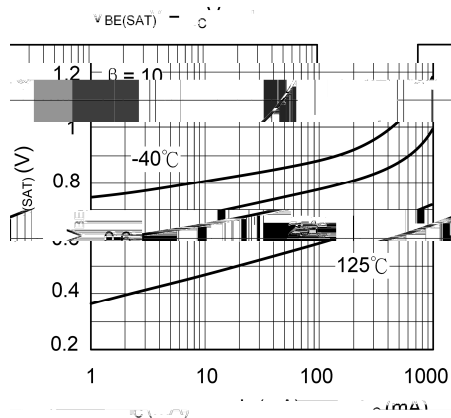
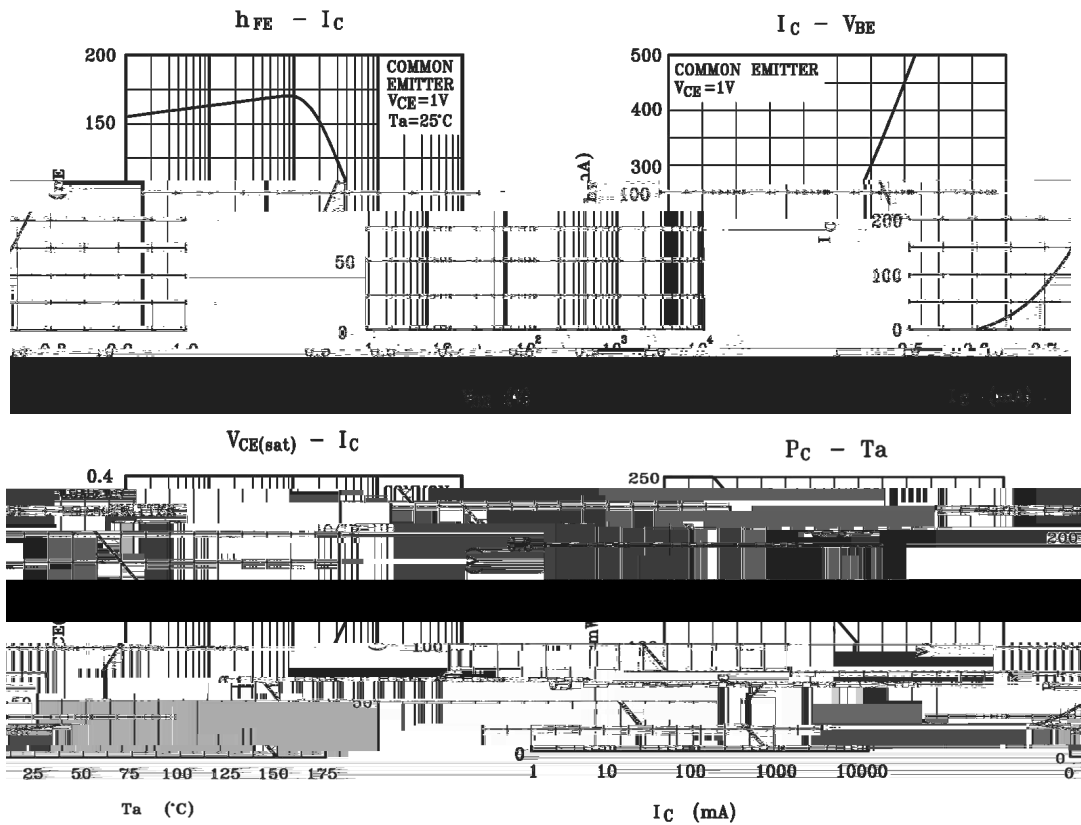


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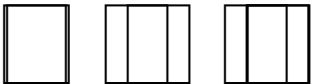
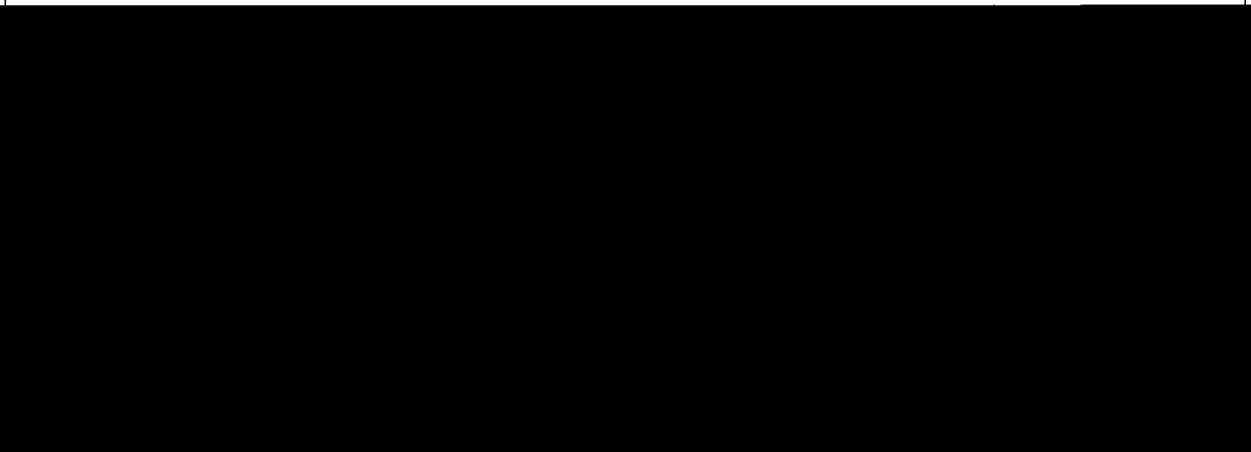
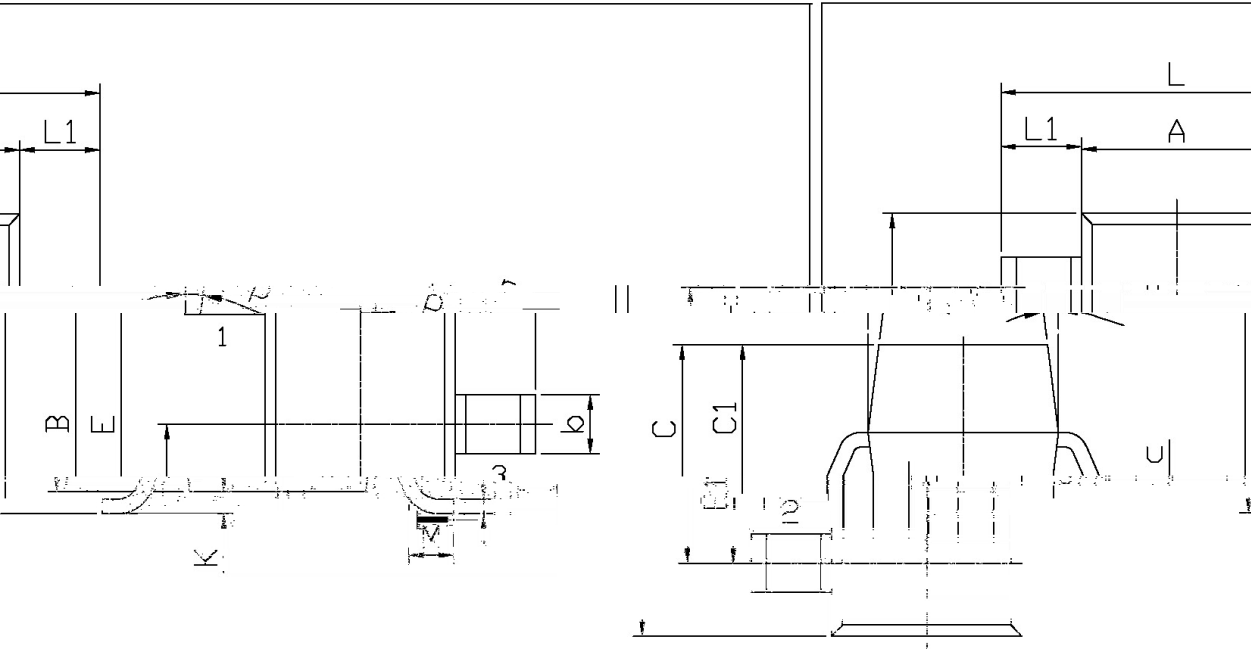
/ Electrical Characteristic Curve



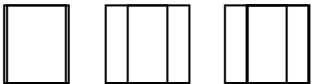
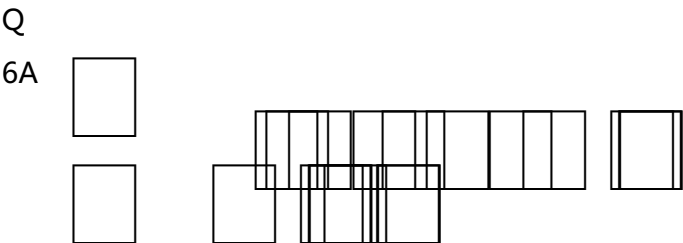
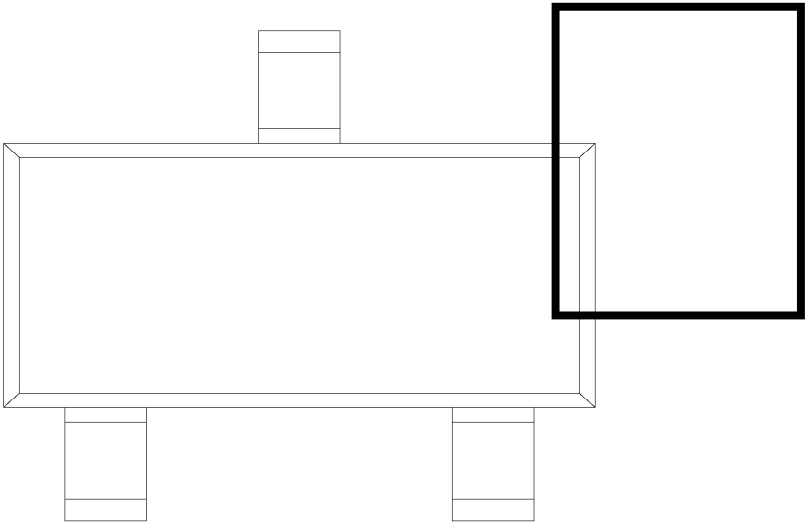
/ Package Dimensions

SOT-23

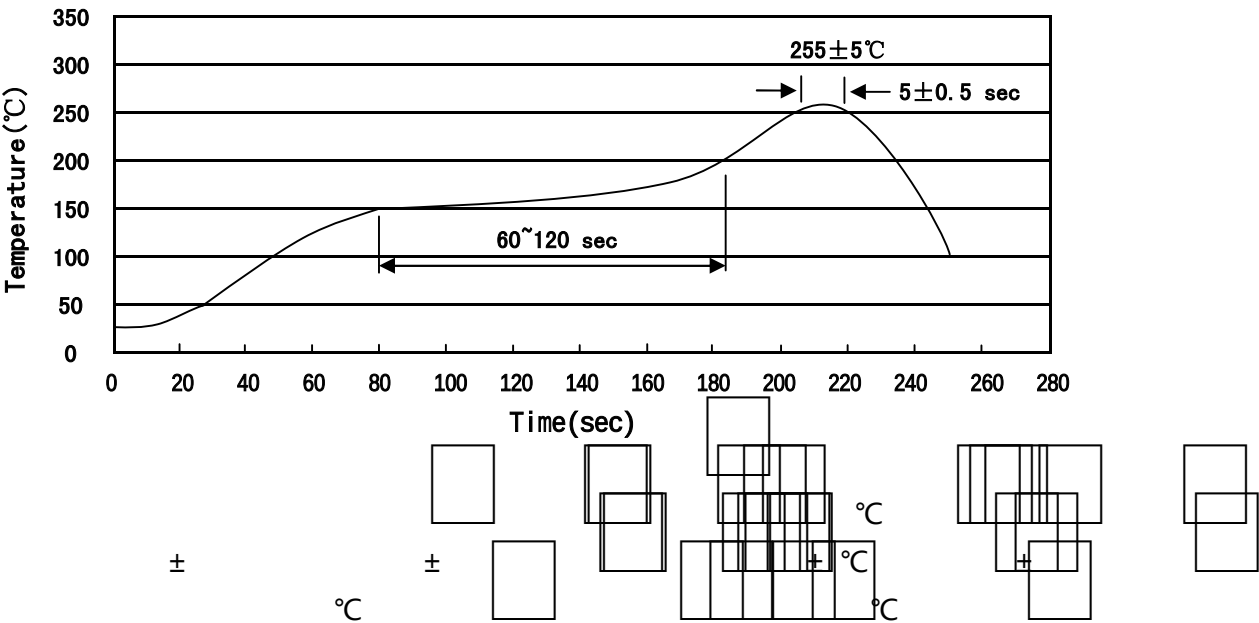
单位: mm



/ Marking Instructions



() / Temperature Profile for IR Reflow Soldering(Pb-Free)



/ Resistance to Soldering Heat Test Conditions



/ Packaging SPEC.

包装数量						包装尺寸		
封装形式	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOT-23	3,000	10	30,000	6	180,000	7" ×8	180×120×180	390×385×205

/ Notices

